



Atty. Dkt. No. 039153-0693 (H1718)

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Applicants: Xiang et al.

Title: SHALLOW TRENCH
ISOLATION PROCESS
AND STRUCTURE WITH
MINIMIZED STRAINED
SILICON CONSUMPTION

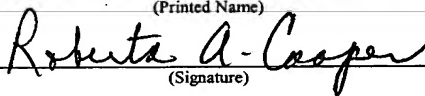
Appl. No.: 10/755,602

Filing Date: 01/12/2004

Examiner: Jack Chen

Art Unit: 2813

Confirmation No.: 9549

CERTIFICATE OF EXPRESS MAILING	
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Roberta A. Cooper	
(Printed Name)	
	
(Signature)	

AMENDMENT AND REPLY

Mail Stop AMENDMENT
Commissioner for Patents
P.O. Box 1450
Alexandria, VA 22313-1450

This communication is responsive to the Non-Final Office Action dated April 6, 2006 concerning the above-referenced patent application.

Amendments to the Claims are reflected in the listing of claims which begins on page 2 of this document.

Remarks/Arguments begin on page 5 of this document.

Please amend the application as follows: